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CMOS Digital Integrated Circuits Silicon Monolithic

74VHC165FT

1. Functional Description

- 8-Bit Shift Register (P-IN, S-OUT)

2. General

The 74VHC165FT is an advanced high speed CMOS 8-BIT PARALLEL/SERIAL-IN, SERIAL-OUT SHIFT REGISTER fabricated with silicon gate C^2MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

It consists of parallel-in or serial-in, serial-out 8-bit shift register with a gated clock input. When the SHIFT/$\overline{\text{LOAD}}$ input is held high, the serial data input is enabled and the eight frip-frops perform serial shifting with each clock pulse.

When the SHIFT/$\overline{\text{LOAD}}$ input is held low, the parallel data is loaded synchronously into the register at positive going transition of the clock pulse.

The CK-INH input should be shifted high only when the CK input is held high.

An Input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and on two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

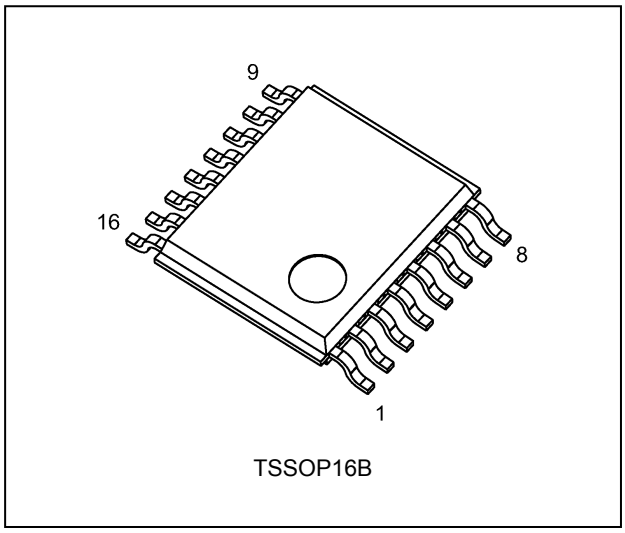
3. Features

(1) AEC-Q100 (Rev. H) (Note 1)
(2) Wide operating temperature range: T_{opr} = -40 to 125 °C
(3) High speed: f_{MAX} = 150 MHz (typ.) at V_{CC} = 5 V
(4) Low power dissipation: I_{CC} = 4.0 μA (max) at T_a = 25 °C
(5) High noise immunity: $V_{NIH} = V_{NIL}$ = 28 % V_{CC} (min)
(6) Power-down protection is provided on all inputs.
(7) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
(8) Wide operating voltage range: $V_{CC(opr)}$ = 2.0 V to 5.5 V
(9) Pin and function compatible with 74 series (74AC/HC/AHC etc.) 165 type.

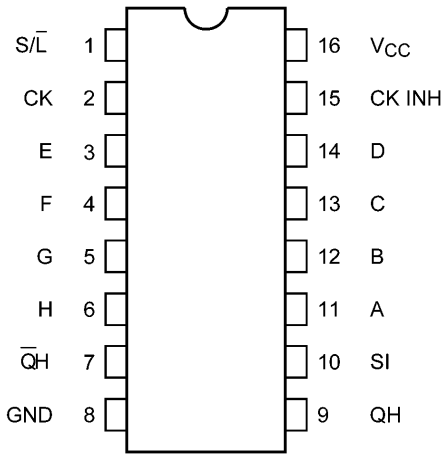
Note 1: This device is compliant with the reliability requirements of AEC-Q100. For details, contact your Toshiba sales representative.

Start of commercial production
2013-05

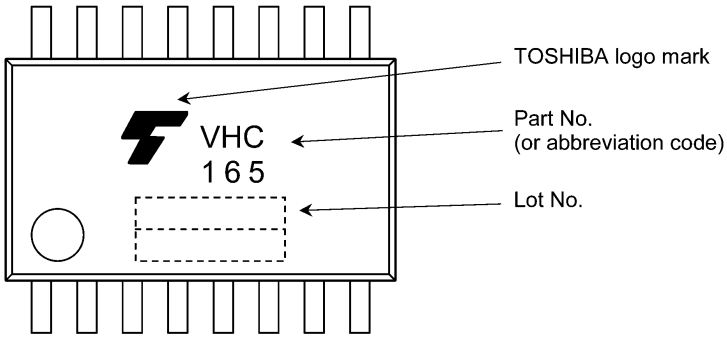
4. Packaging



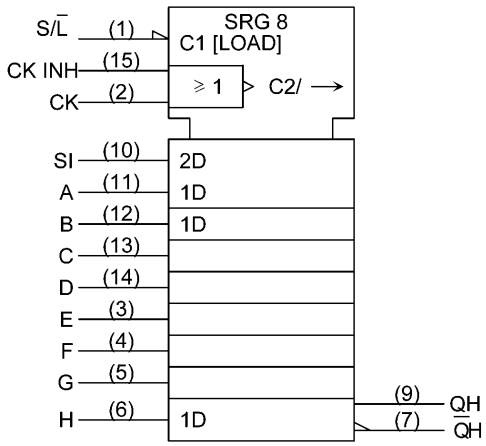
5. Pin Assignment



6. Marking



7. IEC Logic Symbol



8. Truth Table

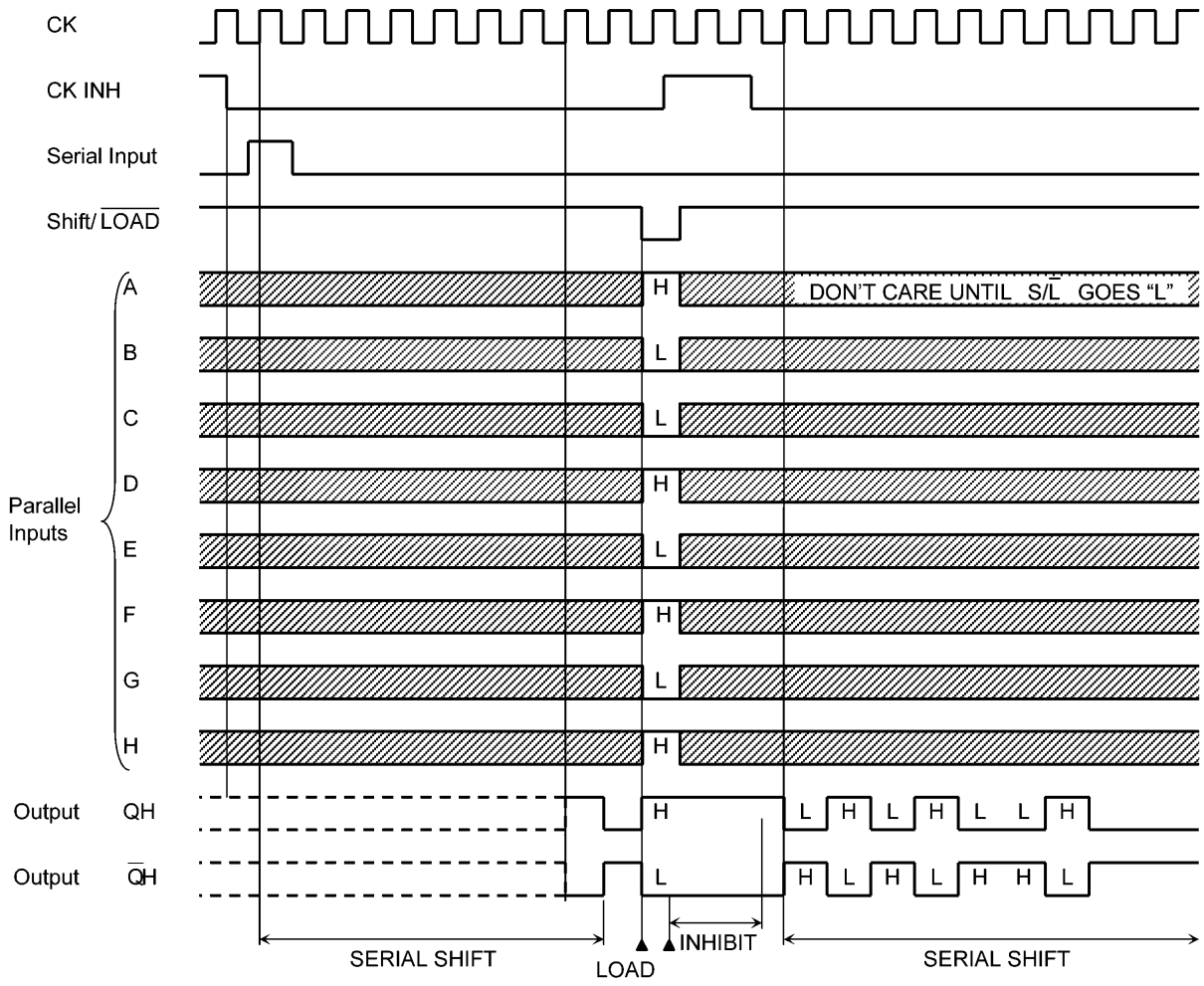
Inputs					Internal Outputs		Outputs	
SHIFT/$\overline{LOAD}$	CK INH	CK	SERIAL IN	PARALLEL A……H	QA	QB	QH	$\overline{QH}$
L	X	X	X	a……h	a	b	h	$\overline{h}$
H	L	↑	H	X	H	QA_n	QG_n	$\overline{QG}_n$
H	L	↑	L	X	L	QA_n	QG_n	$\overline{QG}_n$
H	↑	L	H	X	H	QA_n	QG_n	$\overline{QG}_n$
H	↑	L	L	X	L	QA_n	QG_n	$\overline{QG}_n$
H	X	H	X	X	No Change			
H	H	X	X	X	No Change			

X: Don't care

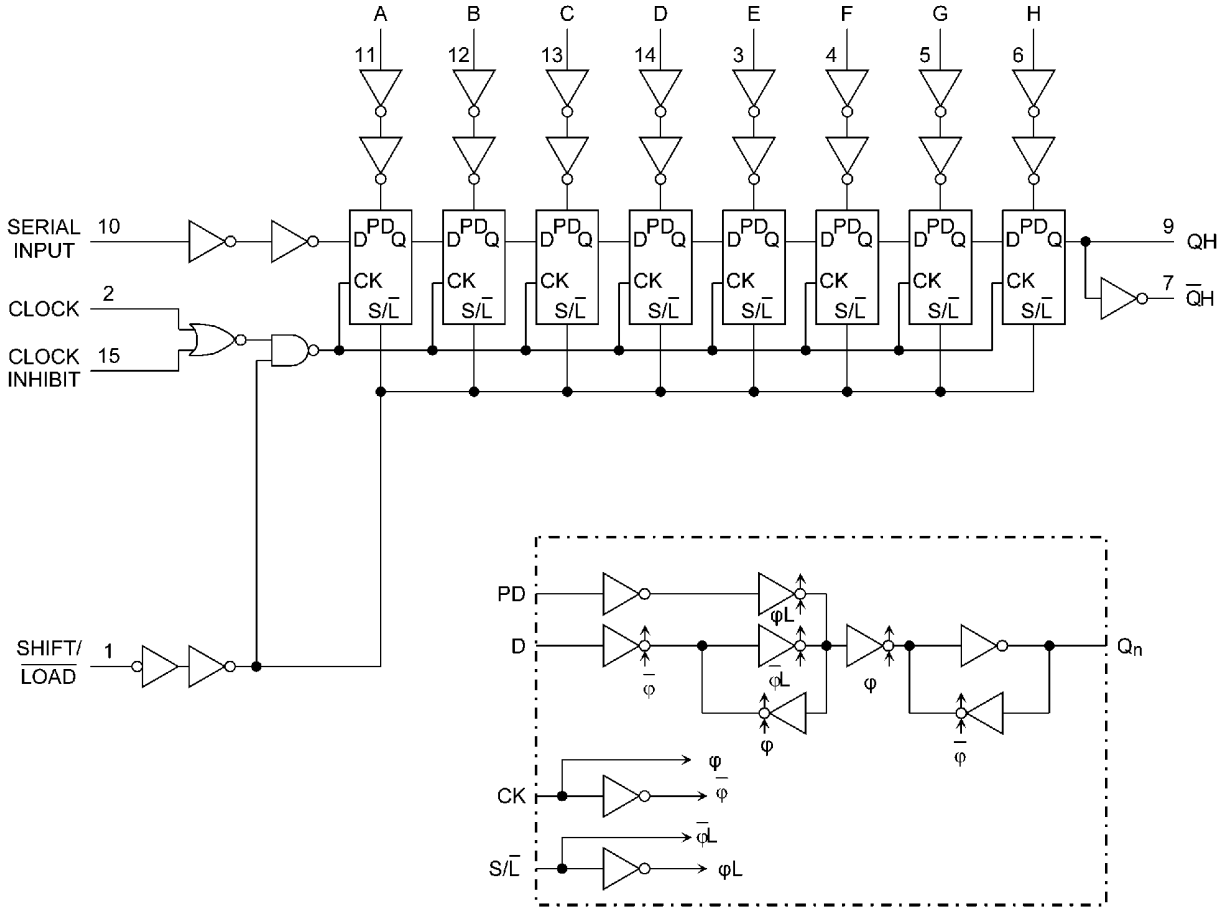
a.....h: The level of steady state input voltage at inputs A through H respectively.

QA_n to QG_n: The level of QA to QG, respectively, before the most recent positive transition of the CK.

9. Timing Diagrams



10. System Diagram



11. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V_{CC}		-0.5 to 7.0	V
Input voltage	V_{IN}		-0.5 to 7.0	V
Output voltage	V_{OUT}		-0.5 to V_{CC} + 0.5	V
Input diode current	I_{IK}		-20	mA
Output diode current	I_{OK}		±20	mA
Output current	I_{OUT}		±25	mA
V_{CC}/ground current	I_{CC}		±50	mA
Power dissipation	P_D	(Note 1)	180	mW
Storage temperature	T_{stg}		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.
Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 180 mW in the range of T_a = -40 to 85 °C. From T_a = 85 to 125 °C a derating factor of -3.25 mW/°C shall be applied until 50 mW.

12. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V_{CC}		2.0 to 5.5	V
Input voltage	V_{IN}		0 to 5.5	V
Output voltage	V_{OUT}		0 to V_{CC}	V
Operating temperature	T_{opr}		-40 to 125	°C
Input rise and fall times	dt/dv	V_{CC} = 3.3 ± 0.3 V	0 to 100	ns/V
		V_{CC} = 5 ± 0.5 V	0 to 20	

Note: The operating ranges must be maintained to ensure the normal operation of the device.
Unused inputs must be tied to either V_{CC} or GND.

13. Electrical Characteristics

13.1. DC Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Test Condition		V_{CC} (V)	Min	Typ.	Max	Unit
High-level input voltage	V_{IH}	—		2.0	1.50	—	—	V
				3.0 to 5.5	V_{CC} × 0.7	—	—	
Low-level input voltage	V_{IL}	—		2.0	—	—	0.50	V
				3.0 to 5.5	—	—	V_{CC} × 0.3	
High-level output voltage	V_{OH}	V_{IN} = V_{IH} or V_{IL}	I_{OH} = -50 μA	2.0	1.9	2.0	—	V
				3.0	2.9	3.0	—	
				4.5	4.4	4.5	—	
			I_{OH} = -4 mA	3.0	2.58	—	—	
			I_{OH} = -8 mA	4.5	3.94	—	—	
Low-level output voltage	V_{OL}	V_{IN} = V_{IH} or V_{IL}	I_{OL} = 50 μA	2.0	—	0.0	0.1	V
				3.0	—	0.0	0.1	
				4.5	—	0.0	0.1	
			I_{OL} = 4 mA	3.0	—	—	0.36	
			I_{OL} = 8 mA	4.5	—	—	0.36	
Input leakage current	I_{IN}	V_{IN} = 5.5 V or GND		0 to 5.5	—	—	±0.1	μA
Quiescent supply current	I_{CC}	V_{IN} = V_{CC} or GND		5.5	—	—	4.0	μA

13.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Condition		V_{CC} (V)	Min	Max	Unit
High-level input voltage	V_{IH}	—		2.0	1.5	—	V
				3.0 to 5.5	V_{CC} × 0.7	—	
Low-level input voltage	V_{IL}	—		2.0	—	0.5	V
				3.0 to 5.5	—	V_{CC} × 0.3	
High-level output voltage	V_{OH}	V_{IN} = V_{IH} or V_{IL}	I_{OH} = -50 μA	2.0	1.9	—	V
				3.0	2.9	—	
				4.5	4.4	—	
			I_{OH} = -4 mA	3.0	2.48	—	
			I_{OH} = -8 mA	4.5	3.80	—	
Low-level output voltage	V_{OL}	V_{IN} = V_{IH} or V_{IL}	I_{OL} = 50 μA	2.0	—	0.1	V
				3.0	—	0.1	
				4.5	—	0.1	
			I_{OL} = 4 mA	3.0	—	0.44	
			I_{OL} = 8 mA	4.5	—	0.44	
Input leakage current	I_{IN}	V_{IN} = 5.5 V or GND		0 to 5.5	—	±1.0	μA
Quiescent supply current	I_{CC}	V_{IN} = V_{CC} or GND		5.5	—	40.0	μA

13.3. DC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C)

Characteristics	Symbol	Test Condition		V_{CC} (V)	Min	Max	Unit
High-level input voltage	V_{IH}	—		2.0	1.50	—	V
				3.0 to 5.5	V_{CC} × 0.7	—	
Low-level input voltage	V_{IL}	—		2.0	—	0.50	V
				3.0 to 5.5	—	V_{CC} × 0.3	
High-level output voltage	V_{OH}	V_{IN} = V_{IH} or V_{IL}	I_{OH} = -50 μA	2.0	1.9	—	V
				3.0	2.9	—	
				4.5	4.4	—	
			I_{OH} = -4 mA	3.0	2.40	—	
			I_{OH} = -8 mA	4.5	3.70	—	
Low-level output voltage	V_{OL}	V_{IN} = V_{IH} or V_{IL}	I_{OL} = 50 μA	2.0	—	0.1	V
				3.0	—	0.1	
				4.5	—	0.1	
			I_{OL} = 4 mA	3.0	—	0.55	
			I_{OL} = 8 mA	4.5	—	0.55	
Input leakage current	I_{IN}	V_{IN} = 5.5 V or GND		0 to 5.5	—	±2.0	μA
Quiescent supply current	I_{CC}	V_{IN} = V_{CC} or GND		5.5	—	80.0	μA

13.4. Timing Requirements (Unless otherwise specified, T_a = 25 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Limit	Unit
Minimum pulse width (CK, CK INH)	$t_{w(L)}$,$t_{w(H)}$	—	3.3 ± 0.3	6.0	ns
			5.0 ± 0.5	4.0	
Minimum pulse width ($S/\overline{L}$)	$t_{w(L)}$	—	3.3 ± 0.3	7.5	ns
			5.0 ± 0.5	5.0	
Minimum setup time (PI-$S/\overline{L}$)	t_s	—	3.3 ± 0.3	7.5	ns
			5.0 ± 0.5	5.0	
Minimum setup time (SI-CK, CK INH)	t_s	—	3.3 ± 0.3	5.0	ns
			5.0 ± 0.5	4.0	
Minimum setup time ($S/\overline{L}$-CK, CK INH)	t_s	—	3.3 ± 0.3	5.0	ns
			5.0 ± 0.5	4.0	
Minimum hold time (PI-$S/\overline{L}$)	t_h	—	3.3 ± 0.3	0.5	ns
			5.0 ± 0.5	1.0	
Minimum hold time (SI-CK, CK INH)	t_h	—	3.3 ± 0.3	0.0	ns
			5.0 ± 0.5	0.5	
Minimum hold time ($S/\overline{L}$-CK, CK INH)	t_h	—	3.3 ± 0.3	0.0	ns
			5.0 ± 0.5	0.5	
Minimum removal time (CK INH-CK), (CK-CK INH)	t_{rem}	—	3.3 ± 0.3	5.0	ns
			5.0 ± 0.5	3.5	

13.5. Timing Requirements (Unless otherwise specified, T_a = -40 to 85 °C, Input: $t_r = t_f$ = 3 ns)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Limit	Unit
Minimum pulse width (CK, CK INH)	$t_{w(L)}$,$t_{w(H)}$	—	3.3 ± 0.3	7.0	ns
			5.0 ± 0.5	4.0	
Minimum pulse width ($S/\overline{L}$)	$t_{w(L)}$	—	3.3 ± 0.3	9.0	ns
			5.0 ± 0.5	6.0	
Minimum setup time (PI-$S/\overline{L}$)	t_s	—	3.3 ± 0.3	8.5	ns
			5.0 ± 0.5	5.0	
Minimum setup time (SI-CK, CK INH)	t_s	—	3.3 ± 0.3	6.0	ns
			5.0 ± 0.5	4.0	
Minimum setup time ($S/\overline{L}$-CK, CK INH)	t_s	—	3.3 ± 0.3	6.0	ns
			5.0 ± 0.5	4.0	
Minimum hold time (PI-$S/\overline{L}$)	t_h	—	3.3 ± 0.3	0.5	ns
			5.0 ± 0.5	1.0	
Minimum hold time (SI-CK, CK INH)	t_h	—	3.3 ± 0.3	0.0	ns
			5.0 ± 0.5	0.5	
Minimum hold time ($S/\overline{L}$-CK, CK INH)	t_h	—	3.3 ± 0.3	0.0	ns
			5.0 ± 0.5	0.5	
Minimum removal time (CK INH-CK), (CK-CK INH)	t_{rem}	—	3.3 ± 0.3	5.0	ns
			5.0 ± 0.5	3.5	

13.6. Timing Requirements (Unless otherwise specified, T_a = -40 to 125 °C, Input: $t_r = t_f$ = 3 ns)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Limit	Unit
Minimum pulse width (CK, CK INH)	$t_{w(L)}$,$t_{w(H)}$	—	3.3 ± 0.3	7.0	ns
			5.0 ± 0.5	4.0	
Minimum pulse width ($S/\overline{L}$)	$t_{w(L)}$	—	3.3 ± 0.3	9.0	ns
			5.0 ± 0.5	6.0	
Minimum setup time (PI-$S/\overline{L}$)	t_s	—	3.3 ± 0.3	8.5	ns
			5.0 ± 0.5	5.0	
Minimum setup time (SI-CK, CK INH)	t_s	—	3.3 ± 0.3	6.0	ns
			5.0 ± 0.5	4.0	
Minimum setup time ($S/\overline{L}$-CK, CK INH)	t_s	—	3.3 ± 0.3	6.0	ns
			5.0 ± 0.5	4.0	
Minimum hold time (PI-$S/\overline{L}$)	t_h	—	3.3 ± 0.3	0.5	ns
			5.0 ± 0.5	1.0	
Minimum hold time (SI-CK, CK INH)	t_h	—	3.3 ± 0.3	0.0	ns
			5.0 ± 0.5	0.5	
Minimum hold time ($S/\overline{L}$-CK, CK INH)	t_h	—	3.3 ± 0.3	0.0	ns
			5.0 ± 0.5	0.5	
Minimum removal time (CK INH-CK), (CK-CK INH)	t_{rem}	—	3.3 ± 0.3	5.0	ns
			5.0 ± 0.5	3.5	

13.7. AC Characteristics (Unless otherwise specified, T_a = 25 °C, Input: $t_r = t_f$ = 3 ns)

Characteristics	Symbol	Note	Test Condition	V_{CC} (V)	C_L (pF)	Min	Typ.	Max	Unit
Propagation delay time (CK, CK INH-QH, $\overline{Q}$H)	t_{PLH},t_{PHL}		—	3.3 ± 0.3	15	—	9.9	15.4	ns
					50	—	12.4	18.9	
				5.0 ± 0.5	15	—	6.6	9.9	
					50	—	8.1	11.9	
Propagation delay time (S/$\overline{L}$-QH, $\overline{Q}$H)	t_{PLH},t_{PHL}		—	3.3 ± 0.3	15	—	9.9	15.8	ns
					50	—	12.4	19.3	
				5.0 ± 0.5	15	—	6.7	9.9	
					50	—	8.2	11.9	
Propagation delay time (H-QH, $\overline{Q}$H)	t_{PLH},t_{PHL}		—	3.3 ± 0.3	15	—	9.2	14.1	ns
					50	—	11.7	17.6	
				5.0 ± 0.5	15	—	5.9	9.0	
					50	—	7.4	11.0	
Maximum clock frequency	f_{MAX}		—	3.3 ± 0.3	15	65	85	—	MHz
					50	60	105	—	
				5.0 ± 0.5	15	110	150	—	
					50	95	130	—	
Input capacitance	C_{IN}		—			—	4	10	pF
Power dissipation capacitance	C_{PD}	(Note 1)	—			—	50	—	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

$I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}$

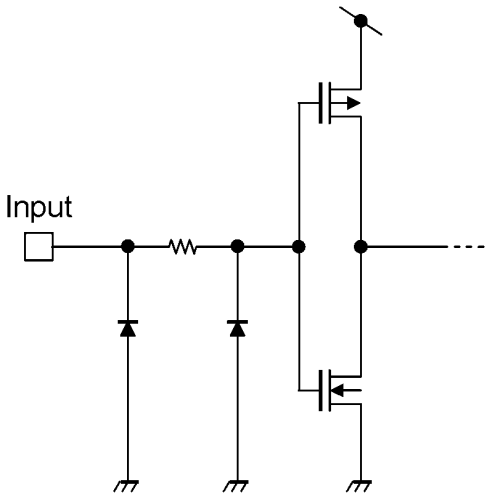
13.8. AC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C, Input: $t_r = t_f$ = 3 ns)

Characteristics	Symbol	Test Condition	V_{CC} (V)	C_L (pF)	Min	Max	Unit
Propagation delay time (CK, CK INH-QH, $\overline{Q}$H)	t_{PLH},t_{PHL}	—	3.3 ± 0.3	15	1.0	18.0	ns
				50	1.0	21.5	
			5.0 ± 0.5	15	1.0	11.5	
				50	1.0	13.5	
Propagation delay time (S/$\overline{L}$-QH, $\overline{Q}$H)	t_{PLH},t_{PHL}	—	3.3 ± 0.3	15	1.0	18.5	ns
				50	1.0	22.0	
			5.0 ± 0.5	15	1.0	11.5	
				50	1.0	13.5	
Propagation delay time (H-QH, $\overline{Q}$H)	t_{PLH},t_{PHL}	—	3.3 ± 0.3	15	1.0	16.5	ns
				50	1.0	20.0	
			5.0 ± 0.5	15	1.0	10.5	
				50	1.0	12.5	
Maximum clock frequency	f_{MAX}	—	3.3 ± 0.3	15	55	—	MHz
				50	50	—	
			5.0 ± 0.5	15	90	—	
				50	85	—	
Input capacitance	C_{IN}	—			—	10	pF

13.9. AC Characteristics
(Unless otherwise specified, T_a = -40 to 125 °C, Input: $t_r = t_f$ = 3 ns)

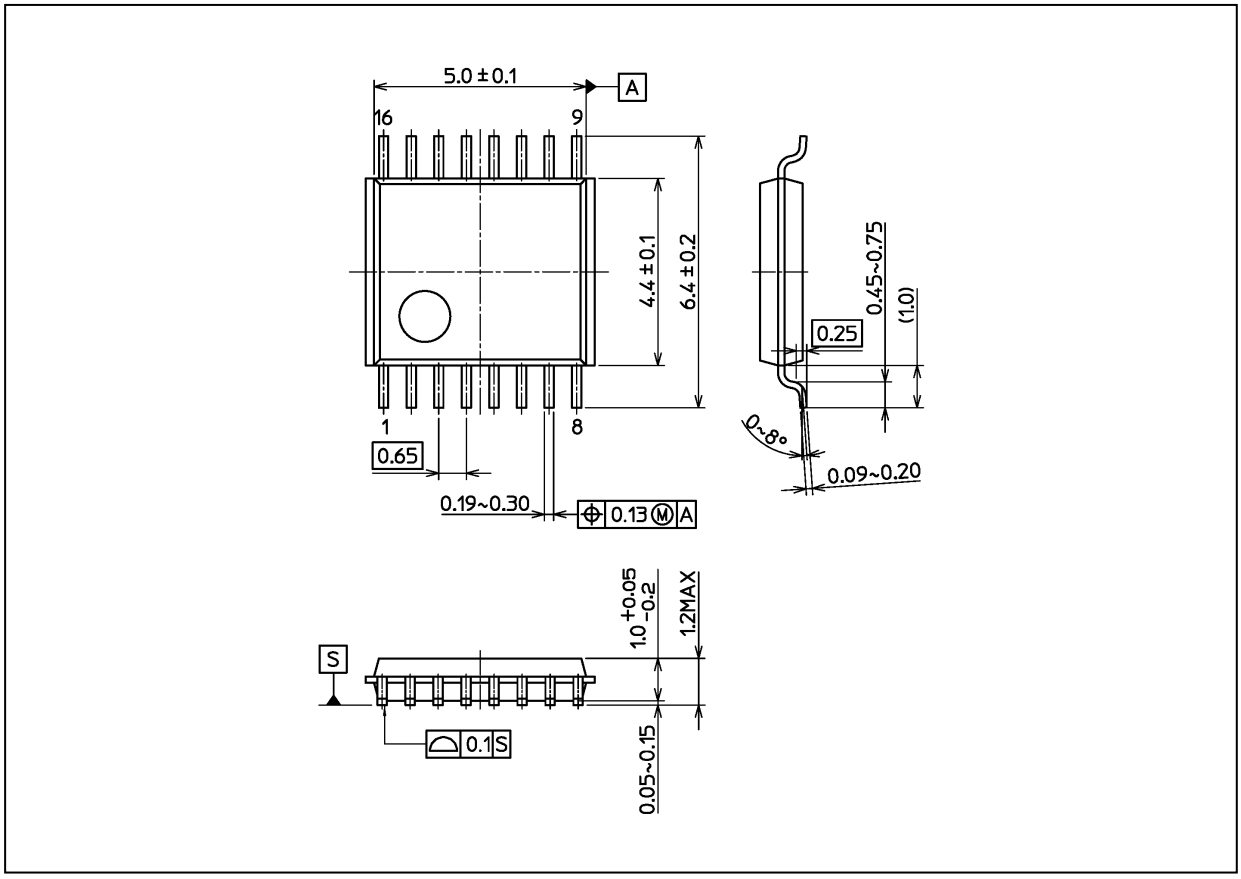
Characteristics	Symbol	Test Condition	V_{CC} (V)	C_L (pF)	Min	Max	Unit
Propagation delay time (CK, CK INH-QH, $\overline{Q}$H)	t_{PLH},t_{PHL}	—	3.3 ± 0.3	15	1.0	20.5	ns
				50	1.0	24.0	
			5.0 ± 0.5	15	1.0	13.0	
				50	1.0	15.0	
Propagation delay time (S/L-QH, $\overline{Q}$H)	t_{PLH},t_{PHL}	—	3.3 ± 0.3	15	1.0	21.0	ns
				50	1.0	24.5	
			5.0 ± 0.5	15	1.0	13.0	
				50	1.0	15.0	
Propagation delay time (H-QH, $\overline{Q}$H)	t_{PLH},t_{PHL}	—	3.3 ± 0.3	15	1.0	18.5	ns
				50	1.0	22.0	
			5.0 ± 0.5	15	1.0	12.0	
				50	1.0	14.0	
Maximum clock frequency	f_{MAX}	—	3.3 ± 0.3	15	50	—	MHz
				50	45	—	
			5.0 ± 0.5	15	85	—	
				50	75	—	
Input capacitance	C_{IN}	—			—	10	pF

14. Internal Equivalent Circuit



Package Dimensions

Unit: mm



Weight: 0.055 g (typ.)

Package Name(s)
Nickname: TSSOP16B

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